



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	Rds(on) Max	I _{D MAX} TA = +25°C
N-	001/	$35m\Omega$ @ V _{GS} = $4.5V$	4.6A
Channel	20V	$43m\Omega$ @ $V_{GS} = 2.5V$	4.2A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

- Load switches
- · Power management functions
- Portable power adaptors

U-DFN2020-6 (Type B) S2 G2 D1 Pin1

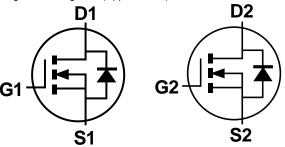
Bottom View

Features

- PCB Footprint of 4mm²
- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (<u>DMN2053UFDBQ</u>)

Mechanical Data

- Package: U-DFN2020-6
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202. Method 208@4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)



Internal Schematic

Ordering Information (Note 4)

Part Number	Packago	Packing		
Part Number	Package	Qty.	Carrier	
DMN2053UFDB-7	U-DFN2020-6 (Type B)	3,000	Tape & Reel	
DMN2053UFDB-13	U-DFN2020-6 (Type B)	10,000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

U-DFN2020-6 (Type B)



H5 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 3 = 2023)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2019	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	9	-	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Υ	Z



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$		I _D	4.6 3.7	А	
Maximum Continuous Body Diode Forward Current (Note 6	Is	1.1	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			IDM	24	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.82	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _θ JA	153	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	1.14	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _θ ЈА	110	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics N-Channel (@ TA = +25°C, unless otherwise specified.)

				1	1		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	1	1.0	μΑ	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	lgss	_		±100	nA	$V_{GS} = \pm 12V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	0.4	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
			23	35		$V_{GS} = 4.5V, I_D = 5A$	
Static Drain-Source On-Resistance	RDS(ON)	_	30	43	mΩ	$V_{GS} = 2.5V, I_{D} = 4A$	
			43	56		V _G S = 1.8V, I _D = 2A	
Diode Forward Voltage	VsD	_	0.7	1.2	V	V _G S = 0V, I _S = 1A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	369	_			
Output Capacitance	Coss	_	54	_	pF	$V_{DS} = 10V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Reverse Transfer Capacitance	Crss	_	32	_		I = I.OWIHZ	
Gate Resistance	Rg	_	4.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	3.6	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	7.7	_	nC	V _{DS} = 10V. I _D = 6A	
Gate-Source Charge	Qgs	_	0.4	_	IIC	VDS = 10V, ID = 6A	
Gate-Drain Charge	Q_{gd}	_	1.0	_			
Turn-On Delay Time	td(ON)	_	2.6	_			
Turn-On Rise Time	t _R	_	3.0	_	no	$V_{DS} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	12.5	_	ns	$R_g = 6\Omega$, $R_L = 10\Omega$, $I_D = 6A$	
Turn-Off Fall Time	tF	_	3.6	_			
Reverse Recovery Time	trr	_	6.0	_	ns	I _F = 1A, di/dt = 100A/μs	
Reverse Recovery Charge	Qrr	_	0.9	_	nC	I _F = 1A, di/dt = 100A/μs	

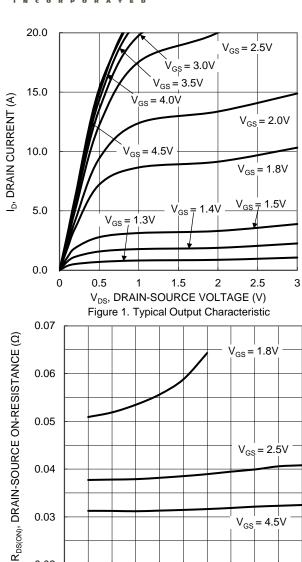
5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.

^{6.} Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.







 I_D , DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

3 4 5 6 $V_{GS} = 4.5V$

10

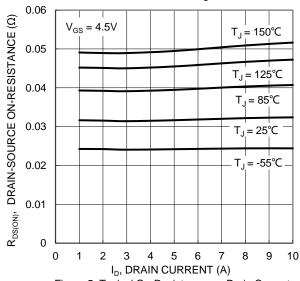
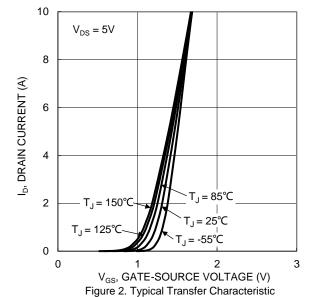


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



0.09 $R_{\mathrm{DS}(ON)},$ DRAIN-SOURCE ON-RESISTANCE (Ω) $I_D = 2A$ 0.08 $I_D = 4A$ 0.07 0.06 0.05 = 5A 0.04 0.03 0.02 0.01 0 0 6 8 10 12 V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 4. Typical Transfer Characteristic

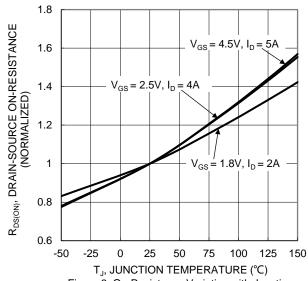


Figure 6. On-Resistance Variation with Junction Temperature

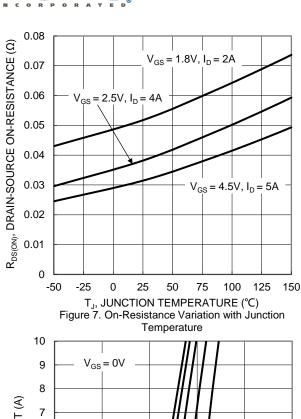
0.03

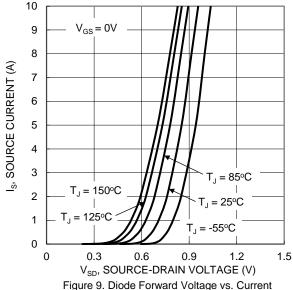
0.02

0









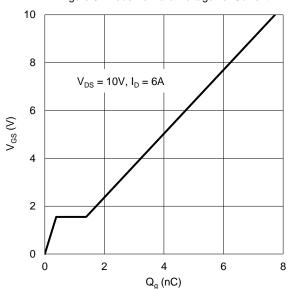


Figure 11. Gate Charge

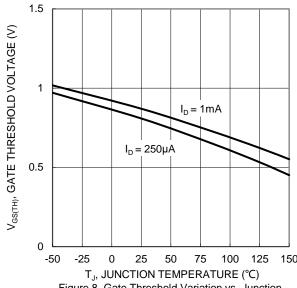
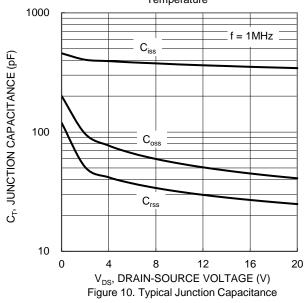
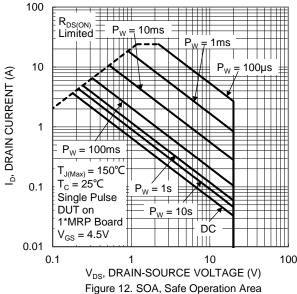


Figure 8. Gate Threshold Variation vs. Junction
Temperature







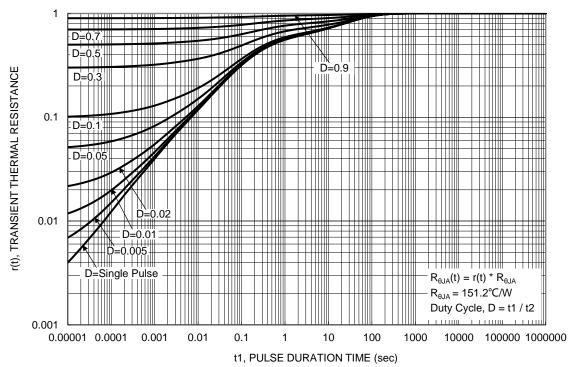


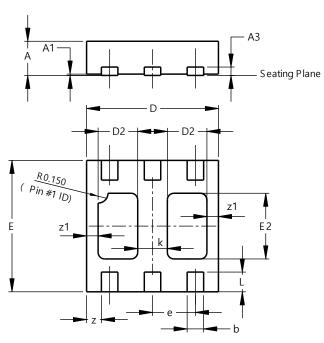
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

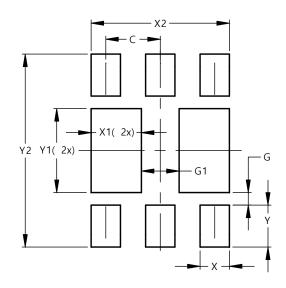
U-DFN2020-6 (Type B)



U-DFN2020-6 Type B								
Dim	Min	Min Max Typ						
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.02					
A3	_	_	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
D2	0.50	0.70	0.60					
e		_	0.65					
Е	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
k	_	_	0.45					
L	0.25	0.35	0.30					
Z	_	_	0.225					
z1	_	_	0.175					
All	Dimens	ions in	mm					

Suggested Pad Layout

U-DFN2020-6 (Type B)



Dimensions	Value
Dillielisions	(in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Y	0.500
Y1	1.000
Y2	2.300



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